Dual 256-Position I²C Compatible Digital Potentiometer

The CAT5271 is a dual 256-position digitally programmable linear taper potentiometer ideally suited for replacing mechanical potentiometers and variable resistors.

The wiper settings are controlled through an I²C-compatible digital interface. Upon power-up, the wiper assumes a midscale position and may be repositioned anytime after the power is stable. The device can be programmed to go to a shutdown state during operation.

The CAT5271 operates from 2.7 V to 5.5 V, while consuming less than 2 μ A. This low operating current, combined with a small package footprint, makes the CAT5271 ideal for battery–powered portable applications.

The CAT5271, designed as a pin for pin replacement for the AD5243, is offered in the 10-lead MSOP package and operates over the -40° C to $+85^{\circ}$ C industrial temperature range.

Features

- Dual 256-position
- End-to-End Resistance: 50 kΩ, 100 kΩ
- I²C Compatible Interface
- Power-on Preset to Midscale
- Single Supply 2.7 V to 5.5 V
- Low Temperature Coefficient 100 ppm/°C
- Low Power, I_{DD} 2 μA max
- Wide Operating Temperature –40°C to +85°C
- RoHS-compliant MSOP-10 Package (3 mm x 4.9 mm)

Typical Applications

- Potentiometer Replacement
- Transducer Adjustment of Pressure, Temperature, Position, Chemical, and Optical Sensors
- RF Amplifier Biasing
- Gain Control and Offset Adjustment



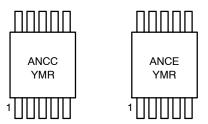
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MSOP-10 R, Z SUFFIX CASE 846AE

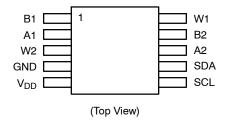
MARKING DIAGRAM



ANCC = $50 \text{ k}\Omega$ ANCE = $100 \text{ k}\Omega$ Y = Production Year (Last Digit) M = Production Month (1 - 9, A, B, C)

R = Revision

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

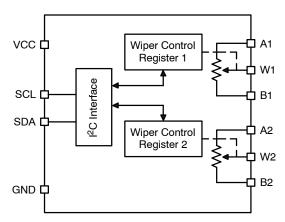


Figure 1. Functional Block Diagram

Table 1. ORDERING INFORMATION

Part Number	Resistance	Temperature Range	Package	Shipping [†]
CAT5271ZI-50-GT3	50 kΩ	−40°C to 85°C	MSOP-10	3000/Tape & Reel
CAT5271ZI-00-GT3	100 kΩ	-40 C t0 65 C	(Pb-Free)	3000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Table 2. PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1	B1	B1 Terminal
2	A1	A1 Terminal
3	W2	W2 Terminal
4	GND	Digital Ground
5	V_{DD}	Positive Power Supply
6	SCL	Serial Clock Input
7	SDA	Serial Data Input / Output
8	A2	A2 Terminal
9	B2	B2 Terminal
10	W1	W1 Terminal

Table 3. ABSOLUTE MAXIMUM RATINGS (Note 1)

Rating	Value	Unit	
V _{DD} to GND	-0.3 to 6.5	V	
A1, B1, W1, A2, B2, W2 Voltage to GND	$V_{ m DD}$		
I _{MAX}	±20	mA	
Digital Inputs and Output Voltage to GND	0 to 6.5	V	
Operating Temperature Range	-40 to +85	°C	
Maximum Junction Temperature (T _{JMAX})	150	°C	
Storage Temperature	-65 to +150	°C	
Lead Temperature (Soldering, 10 sec)	300	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the A, B, and W terminals at a given resistance.

Table 4. ELECTRICAL CHARACTERISTICS: 50 k Ω and 100 k Ω Versions

 V_{DD} = 2.7 V to 5.5 V; V_A = V_{DD} ; V_B = 0 V; $-40^{\circ}C$ < T_A < +85°C; unless otherwise noted. (Note 2)

Parameter	Test Conditions	Symbol	Min	Typ (Note 3)	Max	Unit
DC CHARACTERISTICS — RHEOSTAT I	MODE					
Resistor Differential Nonlinearity (Note 4)	R _{WB} , V _A = no connection	R-DNL	-1	±0.1	+1	LSB
Resistor Integral Nonlinearity (Note 4)	R _{WB} , V _A = no connection	R-INL	-2	±0.4	+2	LSB
Nominal Resistor Tolerance (Note 5)	T _A = 25°C	ΔR_{AB}	-20		+20	%
Resistance Temperature Coefficient	V _{AB} = V _{DD} , Wiper = no connection	$\Delta R_{AB}/\Delta T$		100		ppm/°C
Wiper Resistance	V_{DD} = 5 V, I_W = ±3 mA	R_W		50	120	Ω
	V_{DD} = 3 V, I_W = ±3 mA			100	250	1
DC CHARACTERISTICS — POTENTIOM	ETER DIVIDER MODE					
Resolution		N			8	Bits
Differential Nonlinearity (Note 6)		DNL	-1	±0.1	+1	LSB
Integral Nonlinearity (Note 6)		INL	-1	±0.4	+1	LSB
Voltage Divider Temperature Coefficient	Code = 0x80	$\Delta V_W/\Delta T$		100		ppm/°C
Full-Scale Error	Code = 0xFF	V _{WFSE}	-3	-1	0	LSB
Zero-Scale Error	Code = 0x00	V _{WZSE}	0	1	3	LSB
RESISTOR TERMINALS						
Voltage Range (Note 7)		$V_{A,B,W}$	GND		V_{DD}	V
Capacitance (Note 8) A, B	f = 1 MHz, measured to GND, Code = 0 x 80	C _{A,B}		45		pF
Capacitance (Note 8) W	f = 1 MHz, measured to GND, Code = 0 x 80	C _W		60		pF
Common-Mode Leakage (Note 8)	$V_A = V_B = V_{DD}/2$	I _{CM}		1		nA
DIGITAL INPUTS						
Input Logic High	V _{DD} = 5 V	V _{IH}	0.7 x V _{DD}			V
Input Logic Low	V _{DD} = 5 V	V _{IL}			0.3V _{DD}	V
Input Logic High	V _{DD} = 3 V	V _{IH}	0.7 x V _{DD}			V
Input Logic Low	V _{DD} = 3 V	V_{IL}			0.3V _{DD}	V
Input Current	V _{IN} = 0 V or 5 V	I _I L			±1	μΑ
POWER SUPPLIES				•	•	•
Power Supply Range		V _{DD RANGE}	2.7		5.5	V
Supply Current	V _{IH} = 5 V or V _{IL} = 0 V	I _{DD}		0.3	2	μΑ
Power Dissipation (Note 8)	V _{IH} = 5 V or V _{IL} = 0 V, V _{DD} = 5 V	P _{DISS}			0.2	mW
Power Supply Sensitivity	ΔV_{DD} = +5 V ±10%, Code = Midscale	PSS			±0.05	%/%
DYNAMIC CHARACTERISTICS (Notes 8	and 10)	-	-	-	-	-
Bandwidth –3 dB	$R_{AB} = 50 \text{ k}\Omega / 100 \text{ k}\Omega$, Code = 0x80	BW		100/40		kHz
Total Harmonic Distortion $ \begin{array}{c} V_A = 1 \ V \ rms, \ V_B = 0 \ V, \\ f = 1 \ kHz, \ R_{AB} = 10 \ k\Omega \end{array} $		THD _W		0.05		%
V_W Settling Time (50 kΩ/100 kΩ)	$V_A = 5 \text{ V}, V_B = 0 \text{ V}, \pm 1 \text{ LSB error band}$	t _S		2		μs

- 2. V_A applies to both A1 and A2, V_B applies to both B1 and B2.
- 3. Typical specifications represent average readings at $+25^{\circ}$ C and $V_{DD} = 5 \text{ V}$.
- 4. Resistor position nonlinearity error R-INL is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. Parts are guaran-
- 5. V_{AB} = V_{DD}, Wiper (V_W) = no connect.
 6. INL and DNL are measured at VW with the digital potentiometer configured as a potentiometer divider similar to a voltage output D/A converter. V_A = V_{DD} and V_B = 0 V. DNL specification limits of ±1 LSB maximum are guaranteed monotonic operating conditions.

 7. Resistor terminals A, B, W have no limitations on polarity with respect to each other.
- 8. Guaranteed by design and not subject to production test.
- Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the A, B, and W terminals at a given resistance.
- 10. All dynamic characteristics use $V_{DD} = 5 \text{ V}$.

Table 5. CAPACITANCE

 $T_A=25^{\circ}C,\,f=1.0$ MHz, $V_{DD}=5$ V

Symbol	Test	Conditions	Max	Units
C _{I/O} (Note 11)	Input/Output Capacitance (SDA, SCL)	V _{I/O} = 0V	8	pF

Table 6. POWER UP TIMING (Notes 11 and 12)

Symbol	Parameter		Units
t _{PUR}	Power-up to Read Operation	1	ms
t _{PUW}	Power-up to Write Operation	1	ms

^{11.} This parameter is tested initially and after a design or process change that affects the parameter.

Table 7. DIGITAL POTENTIOMETER TIMING

Symbol	Parameter		Max	Units
t _{WRPO}	Wiper Response Time After Power Supply Stable		50	μs
t _{WR}	Wiper Response Time: SCL falling edge after last bit of wiper position data byte to wiper change		20	μs

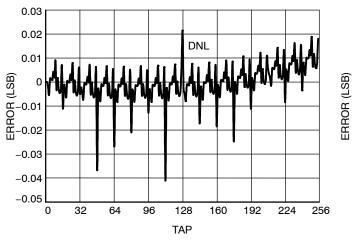
Table 8. A.C. CHARACTERISTICS

 V_{DD} = +2.7 V to +5.5 V, -40°C to +85°C unless otherwise specified.

Symbol	Parameter		Тур	Max	Units
f _{SCL}	Clock Frequency			400	kHz
tHIGH	Clock High Period	600			ns
t _{LOW}	Clock Low Period	1300			ns
t _{SU:STA}	Start Condition Setup Time (for a Repeated Start Condition)	600			ns
t _{HD:STA}	Start Condition Hold Time	600			ns
t _{SU:DAT}	Data in Setup Time	100			ns
t _{HD:DAT}	Data in Hold Time	0			ns
t _{SU:STO}	Stop Condition Setup Time	600			ns
t _{BUF}	Time the bus must be free before a new transmission can start	1300			ns
t _R	SDA and SCL Rise Time			300	ns
t _F	SDA and SCL Fall Time			300	ns
t _{DH}	Data Out Hold Time		100		ns
T _I	Noise Suppression Time Constant at SCL, SDA Inputs			50	ns
t _{AA}	SCL Low to SDA Data Out and ACK Out			1	μs

^{12.} t_{PUR} and t_{PUW} are delays required from the time V_{CC} is stable until the specified operation can be initiated.

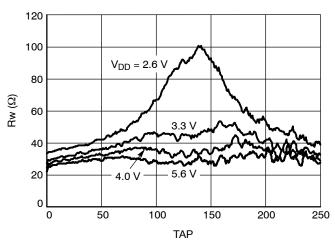
TYPICAL CHARACTERISTICS



0.1 0 -0.1 INL -0.2 -0.3 -0.4 -0.5 32 96 160 192 224 256 64 128 TAP

Figure 2. Differential Non–Linearity, V_{DD} = 5.6 V

Figure 3. Integral Non–Linearity, $V_{DD} = 5.6 \text{ V}$



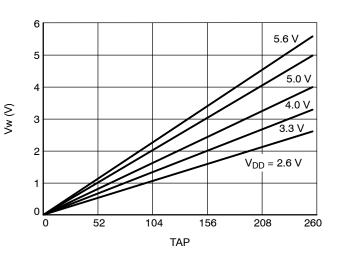


Figure 4. Wiper Resistance at Room Temperature

Figure 5. Wiper Voltage

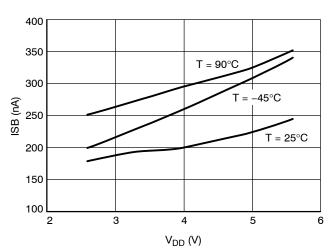


Figure 6. Standby Current

TYPICAL CHARACTERISTICS

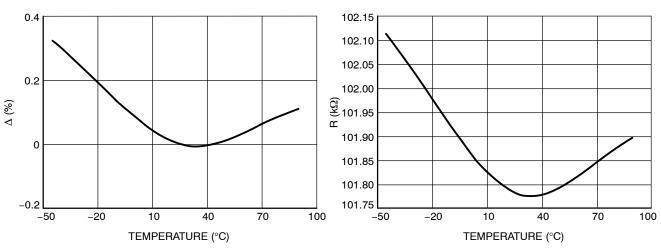


Figure 7. Change in End-to-End Resistance

Figure 8. End-to-End Resistance vs. Temperature

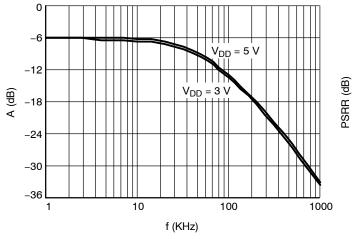


Figure 9. Gain vs. Bandwidth (Tap 0x80)

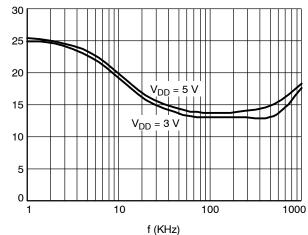


Figure 10. PSRR

Basic Operation

The CAT5271 is a dual 256-position digitally controlled potentiometer. When power is first applied, the wipers assume a mid-scale position. Once the power supply is stable, the wipers may be repositioned via the I²C compatible interface.

Programming: Variable Resistor

Rheostat Mode

The resistance between terminals A and B, R_{AB} , has a nominal value of 50 k Ω or 100 k Ω and has 256 contact points accessed by the wiper terminal, plus the B terminal contact. Data in the 8-bit Wiper register is decoded to select one of these 256 possible settings.

The wiper's first connection is at the B terminal, corresponding to control position 0x00. Ideally this would present a $0~\Omega$ between the Wiper and B, but just as with a mechanical rheostat there is a small amount of contact resistance to be considered, there is a wiper resistance comprised of the R_{ON} of the FET switch connecting the wiper output with its respective contact point. In CAT5271 this 'contact' resistance is typically $50~\Omega$. Thus a connection setting of 0x00 yields a minimum resistance of $50~\Omega$ between terminals W and B.

For a $100 \, k\Omega$ device, the second connection, or the first tap point, corresponds to $441 \, \Omega \, (R_{WB} = R_{AB}/256 + R_W = 390.6 + 50 \, \Omega)$ for data 0x01. The third connection is the next tap point, is $831 \, \Omega \, (2 \, x \, 390.6 + 50 \, \Omega)$ for data 0x02, and so on. Figure 11 shows a simplified equivalent circuit where the last resistor string will not be accessed; therefore, there is 1 LSB less of the nominal resistance at full scale in addition to the wiper resistance.

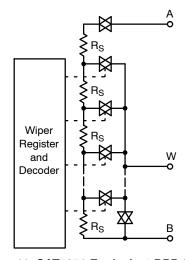


Figure 11. CAT5271 Equivalent DPP Circuit

The equation for determining the digitally programmed output resistance between W and B is

$$R_{WB} = \frac{D}{256} R_{AB} + R_{W}$$
 (eq. 1)

where D is the decimal equivalent of the binary code loaded in the 8-bit Wiper register, R_{AB} is the end-to-end resistance, and R_{W} is the wiper resistance contributed by the on resistance of the internal switch.

In summary, if R_{AB} = 100 k Ω and the A terminal is open circuited, the following output resistance R_{WB} will be set for the indicated Wiper register codes:

Table 9. CODES AND CORRESPONDING R_{WB} RESISTANCE FOR R_{AB} = 100 $k\Omega,\,V_{DD}$ = 5 V

D (Dec.)	R _{WB} (Ω)	Output State
255	99,559	Full Scale (R _{AB} – 1 LSB + R _W)
128	50,050	Midscale
1	441	1 LSB
0	50	Zero Scale (Wiper Contact Resistance)

Be aware that in the zero-scale position, the wiper resistance of 50Ω is still present. Current flow between W and B in this condition should be limited to a maximum pulsed current of no more than 20 mA. Failure to heed this restriction can cause degradation or possible destruction of the internal switch contact.

Similar to the mechanical potentiometer, the resistance of the DPP (Digitally Programmed Potentiometer) between the wiper W and terminal A also produces a digitally controlled complementary resistance R_{WA} . When these terminals are used, the B terminal can be opened. Setting the resistance value for R_{WA} starts at a maximum value of resistance and decreases as the data loaded in the latch increases in value. The general equation for this operation is

$$R_{WA}(D) = \frac{256 - D}{256} R_{AB} + R_{W}$$
 (eq. 2)

For R_{AB} = 100 k Ω and the B terminal open circuited, the following output resistance R_{WA} will be set for the indicated Wiper register codes.

Table 10. CODES AND CORRESPONDING R_{WA} RESISTANCE FOR R_{AB} = 100 k Ω , V_{DD} = 5 V

D (Dec.)	R _{WA} (Ω)	Output State
255	441	Full Scale
128	50,050	Midscale
1	99,659	1 LSB
0	100,050	Zero Scale

Typical device to device resistance matching is lot dependent and may vary by up to $\pm 20\%$.

ESD Protection

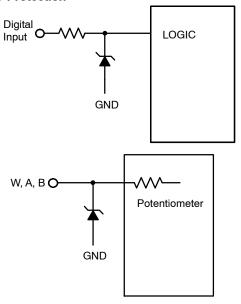
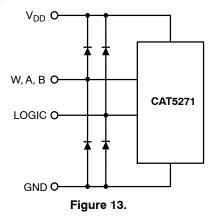


Figure 12. ESD Protection Networks

Terminal Voltage Operating Range

The CAT5271 V_{DD} and GND power supply define the limits for proper 3-terminal digital potentiometer operation. Signals or potentials applied to terminals A, B or the wiper must remain inside the span of V_{DD} and GND. Signals which attempt to go outside these boundaries will be clamped by the internal forward biased diodes.



Power-up Sequence

Because ESD protection diodes limit the voltage compliance at terminals A, B, and W (see Figure 12), it is recommended that V_{DD}/GND be powered before applying any voltage to terminals A, B, and W. The ideal power–up sequence is: GND, V_{DD} , digital inputs, and then $V_{A/B/W}$. The order of powering V_A , V_B , V_W , and the digital inputs is not important as long as they are powered after V_{DD}/GND .

Power Supply Bypassing

Good design practice employs compact, minimum lead length layout design. Leads should be as direct as possible. It is also recommended to bypass the power supplies with quality low ESR Ceramic chip capacitors of 0.01 μF to 0.1 μF . Low ESR 1 μF to 10 μF tantalum or electrolytic capacitors can also be applied at the supplies to suppress transient disturbances and low frequency ripple. As a further precaution digital ground should be joined remotely to the analog ground at one point to minimize the ground bounce.

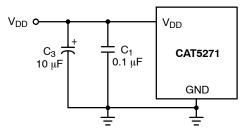


Figure 14. Power Supply Bypassing

I²C Bus Protocol

The following defines the features of the I²C bus protocol:

- 1. Data transfer may be initiated only when the bus is not busy.
- During a data transfer, the data line must remain stable whenever the clock line is high. Any changes in the data line while the clock is high will be interpreted as a START or STOP condition.

The device controlling the transfer is a master, typically a processor or controller, and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the CAT5271 will be considered a slave device in all applications.

START Condition

The START condition precedes all commands to the device, and is defined as a high to low transition of SDA when SCL is high. The CAT5271 monitors the SDA and SCL lines and will not respond until this condition is met.

STOP Condition

A low to high transition of SDA when SCL is high determines the STOP condition. All operations must end with a STOP condition.

Device Addressing

The bus Master begins a transmission by sending a START condition. The Master then sends the address of the particular slave device it is requesting. The seven most significant bits of the 8-bit slave address are fixed as 0101111 for the CAT5271. The next bit (R/\overline{W}) selects between the type of the instruction Read or Write. If the bit

is logic high, then a Read instruction is performed. If the bit is logic low, then the Write command is executed.

After the Master sends a START condition and the slave address byte, the CAT5271 monitors the bus and responds with an acknowledge (on the SDA line) when its address matches the transmitted slave address.

Acknowledge

After a successful data transfer, each receiving device is required to generate an acknowledge. The Acknowledging device pulls down the SDA line during the ninth clock cycle, signaling that it received the 8 bits of data.

The CAT5271 responds with an acknowledge after receiving a START condition and its slave address. If the device has been selected along with a write operation, it responds with an acknowledge after receiving each 8-bit byte.

When the CAT5271 is in a READ mode it transmits 8 bits of data, releases the SDA line, and monitors the line for an acknowledge. Once it receives this acknowledge, the CAT5271 will continue to transmit data. If no acknowledge is sent by the Master, the device terminates data transmission and waits for a STOP condition.

Write Operation

In the Write mode, the Master device sends the START condition and the slave address information to the Slave device. After the Slave generates an acknowledge, the Master sends the instruction byte. After receiving another acknowledge from the Slave, the Master device transmits the data to be written into the wiper register. The CAT5271 acknowledges once more and the Master generates the STOP condition.

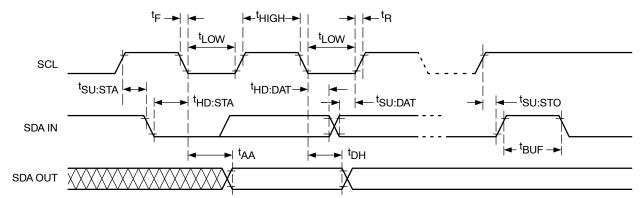


Figure 15. Bus Timing Diagram

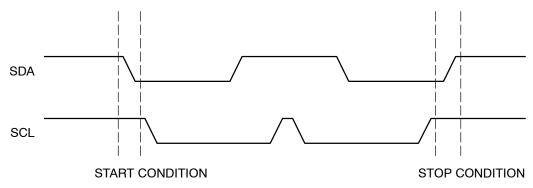


Figure 16. Start/Stop Condition

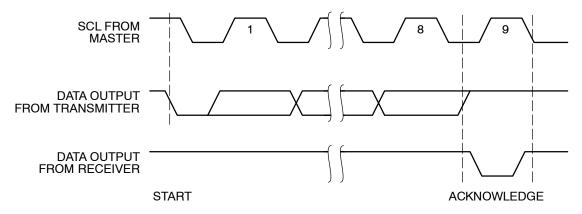


Figure 17. Acknowledge Condition

INSTRUCTION AND REGISTER DESCRIPTION

SLAVE ADDRESS BYTE

The first byte sent to the CAT5271 from the master/processor is called the Slave Address Byte. The most significant seven bits of the slave address are a device type identifier. For the CAT5271, these bits are fixed at 0101111. The following bit (R/\overline{W}) selects between a Read or a Write operation. If the bit is logic high, then a Read instruction is performed. If the bit is low, then the Write command is executed.

INSTRUCTION BYTE

Write and Read instructions are respectively three and two bytes in length. The basic sequence of the two instructions is illustrated in Table 11 and 12.

Write Operation

In the write instruction, the second byte first bit (A0) selects between the potentiometer 1 and 2: a logic low is for the potentiometer 1, and a logic high is for potentiometer 2.

The following bit (SD) is the shutdown bit. A logic high causes an open circuit at terminal A while shorting the wiper terminal W to terminal B. The "shutdown" operation does not change the contents of the wiper register. When the shutdown bit, SD, goes back to a logic low, the previous wiper position is restored. Also during shutdown, new settings can be programmed. As soon as the device is returned from shutdown, the wiper position is set according to the wiper register value.

The remainder of the bits in the instruction byte are don't care bits.

Read Operation

In the read mode, the data byte follows immediately after the acknowledgment of the slave address byte. Data is transmitted over the serial bus in sequences.

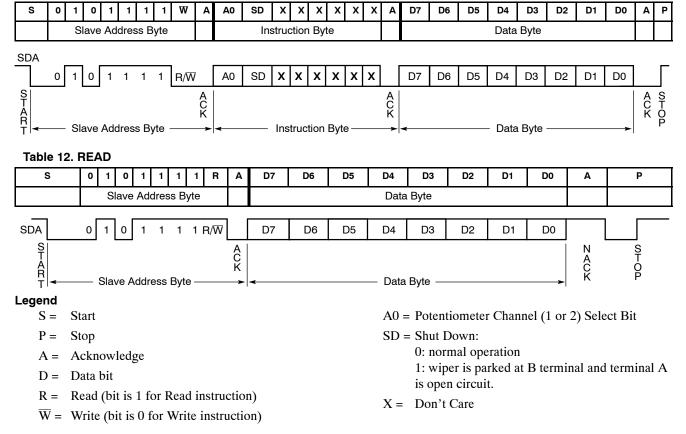
There is no potentiometer channel selection bit in the Read command. The addressed channel is the one that is previously selected in the write mode. If it desired to read the potentiometer wiper register values of both channels, the first potentiometer must be addressed in write mode and then change to read mode to read the first channel value. After that, the user must return the device to write mode with the second potentiometer selected and read the second potentiometer wiper register value in read mode. It is not necessary for users to issue the third data byte in write mode for subsequent read operation.

Wiper Control

The CAT5271 contains two 8-bit Wiper Control Register (WCR). The Wiper Control Register output is decoded to select one of 256 switches along its resistor array. The contents of the WCR may be written by the host via Write instruction.

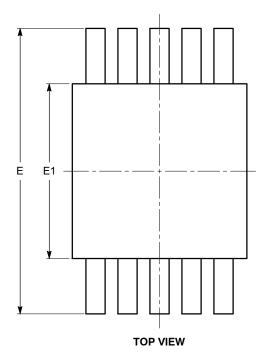
The Wiper Control Registers are a volatile register that loses its contents when the CAT5271 is powered-down. Upon power-up, the wiper is set to midscale and may be repositioned anytime after the power has become stable.

Table 11. Write

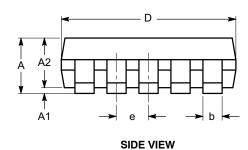


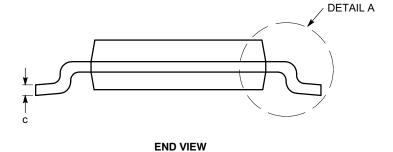
PACKAGE DIMENSIONS

MSOP 10, 3x3 CASE 846AE-01 ISSUE O



SYMBOL	MIN	NOM	MAX		
А			1.10		
A1	0.00	0.05	0.15		
A2	0.75	0.85	0.95		
b	0.17		0.27		
С	0.13		0.23		
D	2.90	3.00	3.10		
E	4.75	4.90	5.05		
E1	2.90	3.00	3.10		
е		0.50 BSC			
L	0.40	0.60	0.80		
L1	0.95 REF				
L2	0.25 BSC				
θ	0°		8°		





Notes:

- (1) All dimensions are in millimeters. Angles in degrees.(2) Complies with JEDEC MO-187.

DETAIL A

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